MAZL000H Series

Silicon planar type

For surge absorption circuit

Features

- Four elements anode-common type
- $P_{tot} = 200 \text{ mW}$

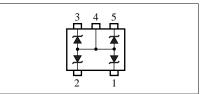
2.90+0.20		Unit: mm
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		0.16+0.10
	(0.65) 1.50 ^{-0.25} 2.8 ^{-0.25}	0.4+00-
	0 to 0.1	
	1: Cathode 1	4: Anode 1, 2
	2: Cathode 2	<i>'</i>
	3: Cathode 3	5: Cathode 4
EIAJ: SC-74A		Mini5-G1 Package

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Total power dissipation *	P _{tot}	200	mW
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Note) *: With a printed circuit board

Internal Connection



Common Electrical Characteristics $T_a = 25^{\circ}C^{*1}$

Parameter	Symbol		Conditions	Min	Тур	Max	Unit	
Zener voltage ^{*2}	VZ	IZ	Specified value					v
Zener knee operating resistance	R _{ZK}	IZ	Specified value	Refer to the list of the electrical characteristics within part numbers				Ω
Zener operating resistance	R _Z	IZ	Specified value					Ω
Reverse current	I _R	V _R	Specified value					μΑ

Note) 1. Test method according to the JIS C7031 testing

2. Electrostatic breakdown voltage is $\pm 10 \text{ kV}$

Test method: IEC1000-4-2 (C = 150 pF, R = 330 Ω , Contact discharge: 10 times)

3. *1: The V_Z value is for the temperature of 25°C. In other cases, carry out the temperature compensation.

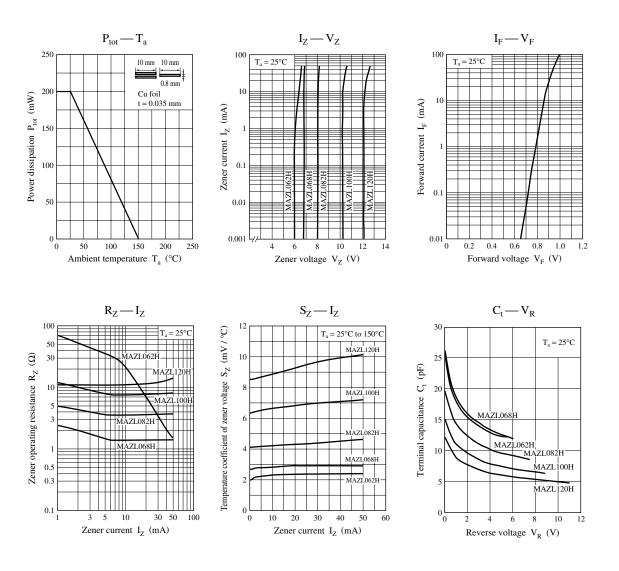
*2: Guaranteed at 20 ms after power application.

	Zener voltage			Reverse current		Zener operating resistance			
Part number		V _Z (V)		I _R (I	I _R (mA)		$R_{ZK}(\Omega)$ $I_{z} = 0.5 \text{ mA}$	Marking symbol	
	Min	Nom	Max	1 _Z (mA)	Max	• R (V)	l _z = 5 mA Max	Max	
MAZL062H	5.8	6.2	6.6	5	0.2	4	50	100	6.2Z
MAZL068H	6.4	6.8	7.2	5	0.1	4	30	60	6.8Z
MAZL082H	7.7	8.2	8.7	5	0.1	5	30	60	8.2Z
MAZL100H	9.4	10.0	10.6	5	0.05	7	30	60	10Z
MAZL120H	11.4	12.0	12.7	5	0.05	9	30	80	12Z

Electrical characteristics within part numbers $T_a = 25^{\circ}C$

Note) 1. The V_Z value is the one after power application for 20 ms at $T_a = 25^{\circ}C$.

2. The zener voltage temperature coefficient is the one for $T_j = 25^{\circ}C$ to $150^{\circ}C$.



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